

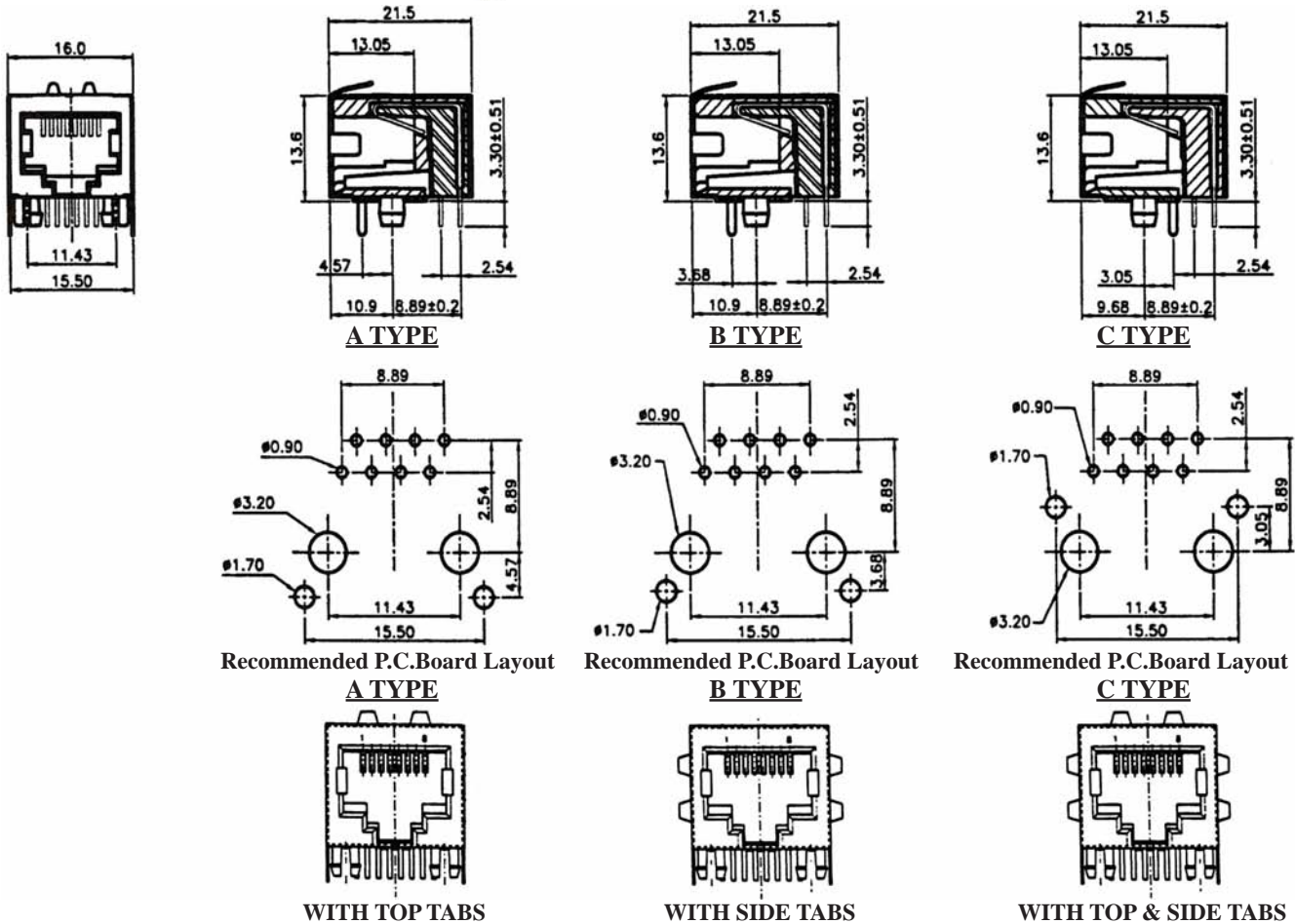
SIDE ENTRY MODULAR PCB JACK 8P PROFILE=13.60MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
Contact Resistance: 20mΩ Max.
Rating Current: 1.5A Max.
Rating Voltage: 120V AC.
Dielectric Voltage: 1000 Vrms 60 Sec. Min.
Temperature Range: -40°C / +85°C
Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
Soldering Temperature: 235°C
Color: Black
Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
Shield: Brass plating Nickel Alloy
All materials must be RoHS compliant.



ORDERING INFORMATION:

P/N MJ $\frac{x}{1}$ - 88 $\frac{x}{2}$ B $\frac{x}{3}$

- CONTACT & PANEL GROUND (TAB) TYPE:
95, 96, 06, 1A, 1B, 1C, 1D, 1E, 1F
V1, V2, V3, V4, V5, V6, V7, V8, V9
- NO. OF POSITIONS & CONTACTS:
"88" 8P8C
- CONTACT FINISH:
"A" 6 MICROINCH GOLD
"B" 15 MICROINCH GOLD
"C" 30 MICROINCH GOLD
"D" 50 MICROINCH GOLD

	STANDARD TYPE			CATEGORY 5		
CONTACT TYPE	A	B	C	A	B	C
WITH TOP TABS	95	96	06	V1	V2	V3
WITH SIDE TABS	1A	1B	1C	V4	V5	V6
WITH TOP & SIDE TABS	1D	1E	1F	V7	V8	V9

NOTE: P/N MJxxHT-88xB for High Temp. Version